



# MOSFET

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V

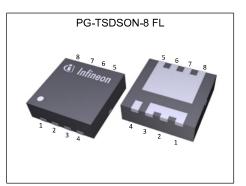
### **Features**

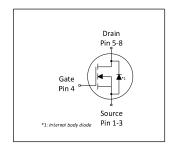
- Ideal for high frequency switching and sync. rec.
   Optimized technology for DC/DC converters
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low on-resistance R<sub>DS(on)</sub>

- N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21
- Higher solder joint reliability with enlarged source interconnection

#### Table 1 **Key Performance Parameters**

Parameter	Value	Unit	
V <sub>DS</sub>	80	V	
R <sub>DS(on),max</sub>	8.4	mΩ	
ID	64	A	
Q <sub>oss</sub>	25	nC	
Q <sub>G</sub> (0V10V)	20	nC	









Type / Ordering Code	Package	Marking	Related Links
BSZ084N08NS5	PG-TSDSON-8 FL	084N08N	-



## **Table of Contents**

Description	1
Maximum ratings	3
Thermal characteristics	3
Electrical characteristics	4
Electrical characteristics diagrams	6
Package Outlines	10
Revision History	11
Trademarks	11
Disclaimer	11



# **1 Maximum ratings** at *T*<sub>A</sub>=25 °C, unless otherwise specified

### Table 2Maximum ratings

	Oh. a l	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	64 41	A	<i>T</i> <sub>C</sub> =25 °C <i>T</i> <sub>C</sub> =100 °C
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	256	A	<i>T</i> <sub>c</sub> =25 °C
Avalanche energy, single pulse <sup>3)</sup>	EAS	-	-	76	mJ	I <sub>D</sub> =20 A, R <sub>GS</sub> =25 Ω
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	Ptot	-	-	63	W	<i>T</i> <sub>c</sub> =25 °C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### **Thermal characteristics** 2

#### Table 3 **Thermal characteristics**

Devenueter	C. mah al	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	1.2	2	K/W	-	
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>4)</sup>	R <sub>thJA</sub>	-	-	60	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual <sup>2)</sup> See Diagram 3 for more detailed information
 <sup>3)</sup> See Diagram 13 for more detailed information

<sup>&</sup>lt;sup>4)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.



# **3** Electrical characteristics at *T*<sub>j</sub>=25 °C, unless otherwise specified

#### Table 4 **Static characteristics**

Parameter	Symphol		Values			Note / Toot Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	80	-	-	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	2.2	3.0	3.8	V	$V_{\rm DS}=V_{\rm GS}, I_{\rm D}=31~\mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	7.1 9.9	8.4 11.9	mΩ	V <sub>GS</sub> =10 V, <i>I</i> <sub>D</sub> =20 A V <sub>GS</sub> =6 V, <i>I</i> <sub>D</sub> =5 A
Gate resistance	R <sub>G</sub>	-	1.2	1.8	Ω	-
Transconductance	$g_{ m fs}$	20	39	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =20 A

## Table 5Dynamic characteristics

Parameter	Course had		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	1400	1820	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	240	312	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	13	22.8	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	13	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	tr	-	5	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	t <sub>d(off)</sub>	-	25	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	5	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$

#### Table 6 Gate charge characteristics<sup>2)</sup>

	Currente e l		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	6.5	-	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	4.4	7	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	7.1	-	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	20	25	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	4.7	-	V	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	17	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	25	33	nC	V <sub>DD</sub> =40 V, V <sub>GS</sub> =0 V

 <sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.
 <sup>2)</sup> See "Gate charge waveforms" for parameter definition.



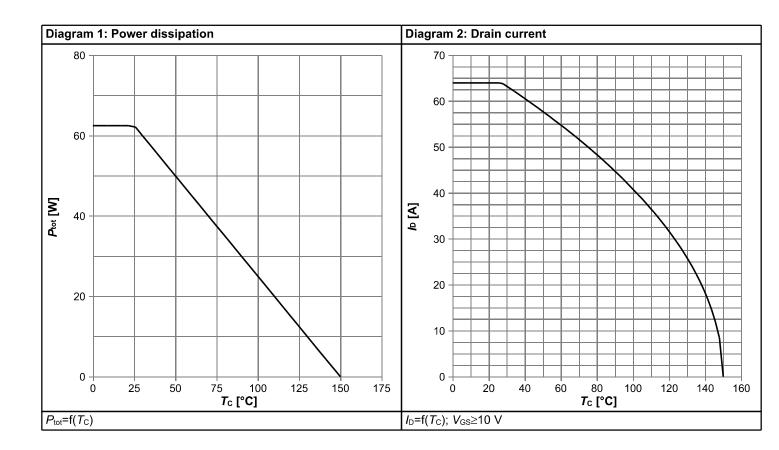
## Table 7Reverse diode

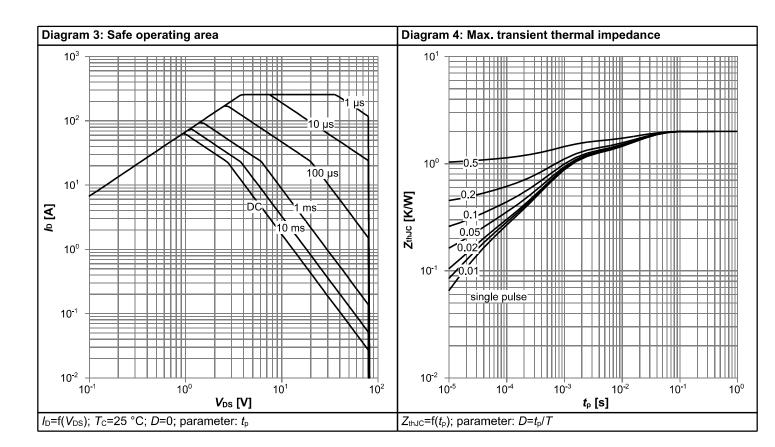
Parameter	Symbol		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	46	А	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	256	А	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.86	1.2	V	$V_{GS}=0$ V, $I_{F}=20$ A, $T_{J}=25$ °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	38	76	ns	V <sub>R</sub> =40 V, I <sub>F</sub> =20 A, di <sub>F</sub> /dt=100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	44	88	nC	V <sub>R</sub> =40 V, <i>I</i> <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.

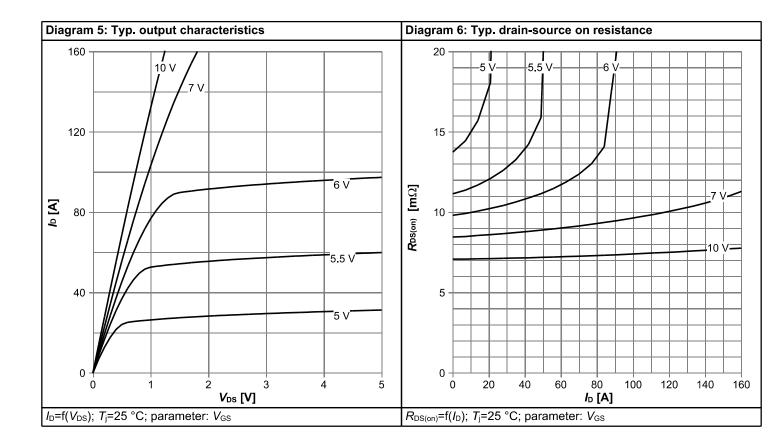


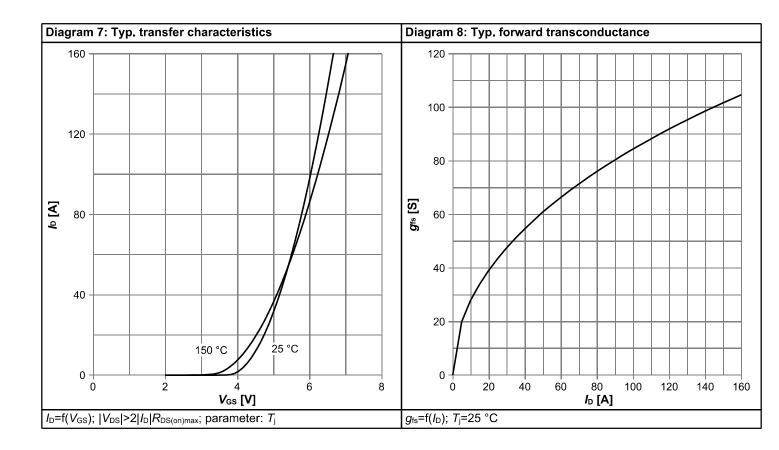
# 4 Electrical characteristics diagrams



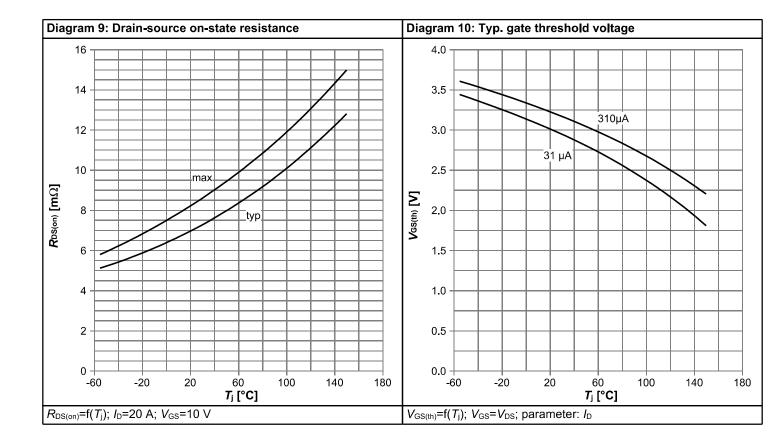


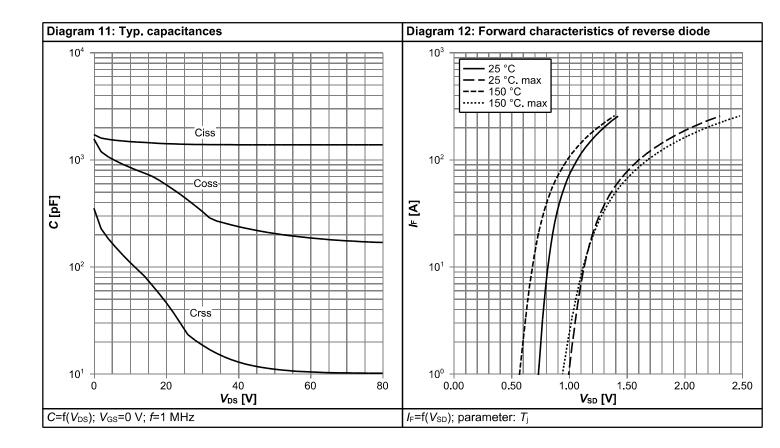




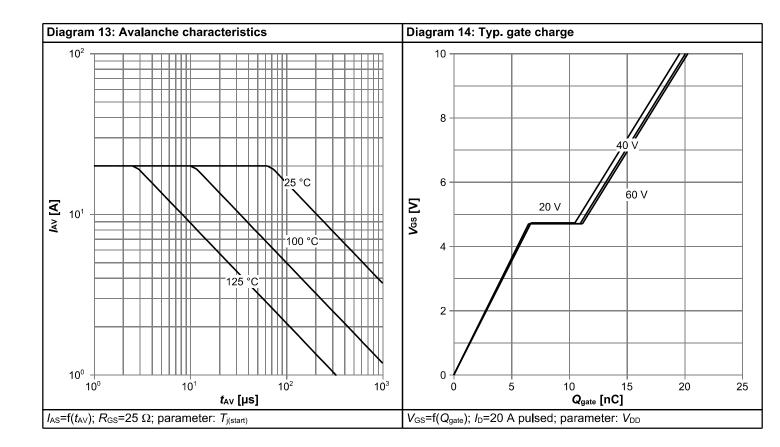


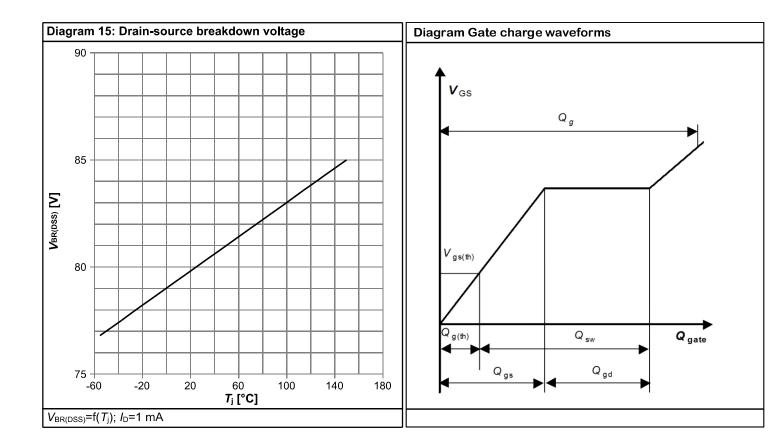






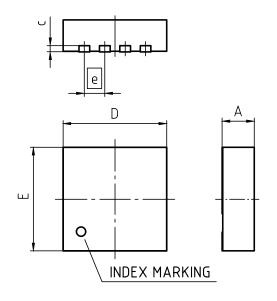


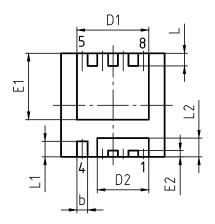






# 5 Package Outlines





PACKAGE - GROUP NUMBER:	ON-8-U03					
<b>REVISION: 03</b>	DATE:	20.10.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
A	0.90	1.10				
b	0.24	0.44				
c	(0.20)					
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.65					
L	0.30	0.50				
L1	0.40 0.60					
L2	0.50 0.70					
aaa	0.0	)6				

# Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



## **Revision History**

BSZ084N08NS5

### Revision: 2021-06-23, Rev. 2.2

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2014-12-17	Release of final version				
2.1	2020-11-09	Update package drawing, footnotes and Diagram 13				
2.2	2021-06-23	Update Id max current rating				

#### Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

### We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to: erratum@infineon.com

#### Published by Infineon Technologies AG 81726 München, Germany © 2020 Infineon Technologies AG All Rights Reserved.

### Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

#### Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

#### Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon: BSZ084N08NS5ATMA1